# Zener Transient Voltage Suppressor POWERMITE® Package

The 1PMT5.0AT1/T3 Series is designed to protect voltage sensitive components from high voltage, high energy transients. Excellent clamping capability, high surge capability, low Zener impedance and fast response time. The advanced packaging technique provides for a highly efficient micro miniature, space saving surface mount with its unique heatsink design. The POWERMITE has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles (1.1 mm) in the industry. Because of its small size, it is ideal for use in cellular phones, portable devices, business machines, power supplies and many other industrial/consumer applications.

## **Specification Features:**

- Stand-off Voltage: 5.0 V 58 V
- Peak Power 200 W @ 1 ms (1PMT5.0A 1PMT36A)
  - 175 W @ 1 ms (1PMT40A 1PMT58A)
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Low Profile Maximum Height of 1.1 mm
- Integral Heatsink/Locking Tabs
- Full Metallic Bottom Eliminates Flux Entrapment
- Small Footprint Footprint Area of 8.45 mm<sup>2</sup>
- POWERMITE is JEDEC Registered as DO-216AA
- Lead Orientation in Tape: Cathode (Short) Lead to Sprocket Holes
- Cathode Indicated by Polarity Band
- Pb-Free Packages are Available

#### **Mechanical Characteristics:**

**CASE:** Void-free, transfer-molded, thermosetting plastic

FINISH: All external surfaces are corrosion resistant and leads are

readily solderable

**MOUNTING POSITION:** Any

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

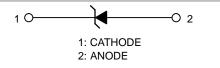
260°C for 10 Seconds



#### ON Semiconductor®

http://onsemi.com

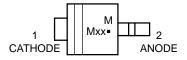
## PLASTIC SURFACE MOUNT ZENER OVERVOLTAGE TRANSIENT SUPPRESSOR 5 – 58 V 200 W PEAK POWER





POWERMITE CASE 457 PLASTIC

#### **MARKING DIAGRAM**



M = Date Code

Mxx = Specific Device Code (See Table on Page 3)

= Pb-Free Package

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
1PMTxxAT1	POWERMITE	3,000/Tape & Reel
1PMTxxAT1G	POWERMITE (Pb-Free)	3,000/Tape & Reel
1PMTxxAT3	POWERMITE	12,000/Tape & Reel
1PMTxxAT3G	POWERMITE (Pb-Free)	12,000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **MAXIMUM RATINGS**

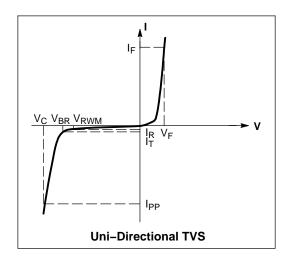
Rating	Symbol	Value	Unit
Maximum P <sub>pk</sub> Dissipation, (PW-10/1000 μs) (Note 1) (1PMT5.0A – 1PMT36A)	P <sub>pk</sub>	200	W
Maximum P <sub>pk</sub> Dissipation, (PW-10/1000 μs) (Note 1) (1PMT40A - 1PMT58A)	P <sub>pk</sub>	175	W
Maximum P <sub>pk</sub> Dissipation, (PW-8/20 μs) (Note 1)	P <sub>pk</sub>	1000	W
DC Power Dissipation @ T <sub>A</sub> = 25°C (Note 2) Derate above 25°C Thermal Resistance, Junction–to–Ambient	$P_{D}$ $R_{ hetaJA}$	500 4.0 248	mW mW/°C °C/W
Thermal Resistance, Junction-to-Lead (Anode)	$R_{\theta Janode}$	35	°C/W
Maximum DC Power Dissipation (Note 3) Thermal Resistance, Junction–to–Tab (Cathode)	$P_{D}$ $R_{ heta J cathode}$	3.2 23	W °C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- Nonrepetitive current pulse at T<sub>A</sub> = 25°C.
   Mounted with recommended minimum pad size, DC board FR-4.
   At Tab (Cathode) temperature, T<sub>tab</sub> = 75°C

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 3.5$ V Max. @ $I_F$ (Note 4) = 35 A)

Symbol	Parameter				
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current				
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>				
V <sub>RWM</sub>	Working Peak Reverse Voltage				
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>				
$V_{BR}$	Breakdown Voltage @ I <sub>T</sub>				
I <sub>T</sub>	Test Current				
I <sub>F</sub>	Forward Current				
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>				



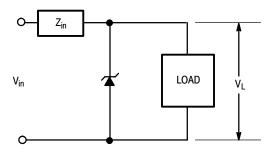
## **ELECTRICAL CHARACTERISTICS** ( $T_L = 30^{\circ}C$ unless otherwise noted, $V_F = 1.25$ Volts @ 200 mA)

		V <sub>RWM</sub>	V <sub>BR</sub> @ I <sub>T</sub> (V) (Note 6)		Ι <sub>Τ</sub>	I <sub>R</sub> @ V <sub>RWM</sub>	V <sub>C</sub> @ I <sub>PP</sub>	I <sub>PP</sub> (A)	
Device*	Marking	(Note 5)	Min	Nom	Max	(mA)	(μΑ)	(V)	(Note 7)
1PMT5.0AT1, T3, G	MKE	5.0	6.4	6.7	7.0	10	50	9.2	21.7
1PMT7.0AT1, T3, G	MKM	7.0	7.78	8.2	8.6	10	30	12	16.7
1PMT12AT1, T3, G	MLE	12	13.3	14.0	14.7	1.0	1.0	19.9	10.1
1PMT16AT1, T3, G	MLP	16	17.8	18.75	19.7	1.0	1.0	26	7.7
1PMT18AT1, T3	MLT	18	20.0	21.0	22.1	1.0	1.0	29.2	6.8
1PMT22AT1, T3	MLX	22	24.4	25.6	26.9	1.0	1.0	35.5	5.6
1PMT24AT1, T3	MLZ	24	26.7	28.1	29.5	1.0	1.0	38.9	5.1
1PMT26AT1, T3	MME	26	28.9	30.4	31.9	1.0	1.0	42.1	4.8
1PMT28AT1, T3, G	MMG	28	31.1	32.8	34.4	1.0	1.0	45.4	4.4
1PMT30AT1, T3, G	MMK	30	33.3	35.1	36.8	1.0	1.0	48.4	4.1
1PMT33AT1, T3, G	MMM	33	36.7	38.7	40.6	1.0	1.0	53.3	3.8
1PMT36AT1, T3	MMP	36	40.0	42.1	44.2	1.0	1.0	58.1	3.4
1PMT40AT1, T3	MMR	40	44.4	46.8	49.1	1.0	1.0	64.5	2.7
1PMT48AT1, T3	MMX	48	53.3	56.1	58.9	1.0	1.0	77.4	2.3
1PMT51AT1, T3	MMZ	51	56.7	59.7	62.7	1.0	1.0	82.4	2.1
1PMT58AT1, T3	MNG	58	64.4	67.8	71.2	1.0	1.0	93.6	1.9

 <sup>4. 1/2</sup> sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.
 5. A transient suppressor is normally selected according to the Working Peak Reverse Voltage (V<sub>RWM</sub>) which should be equal to or greater than the DC or continuous peak operating voltage level.
 6. V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at ambient temperature of 25°C.
 7. Surge current waveform per Figure 2 and derate per Figure 4.

<sup>\*</sup>The "G" suffix indicates Pb-Free package available.

#### TYPICAL PROTECTION CIRCUIT



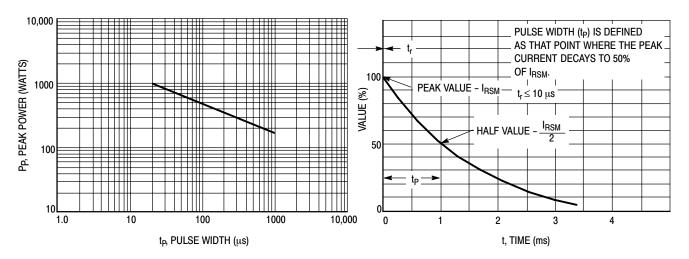


Figure 1. Pulse Rating Curve

Figure 2. 10 X 1000  $\mu s$  Pulse Waveform

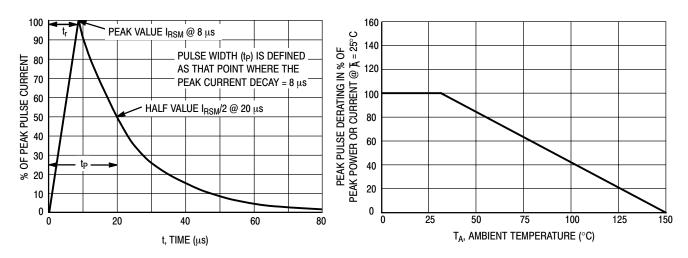


Figure 3. 8 X 20 µs Pulse Waveform

Figure 4. Pulse Derating Curve

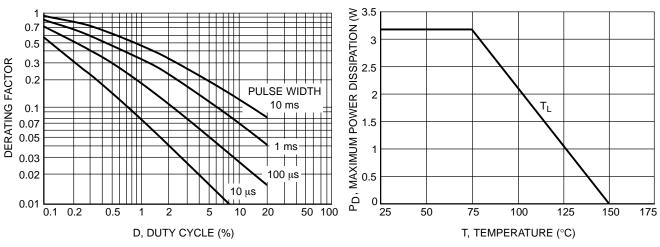


Figure 5. Typical Derating Factor for Duty Cycle

Figure 6. Steady State Power Derating

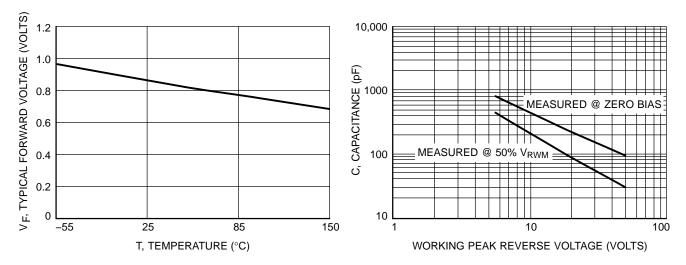


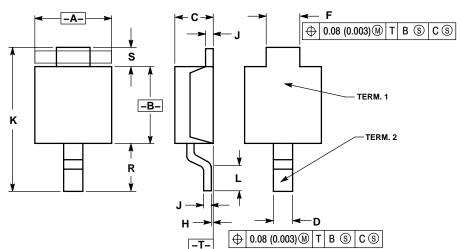
Figure 7. Forward Voltage

Figure 8. Capacitance versus Working Peak Reverse Voltage

#### **OUTLINE DIMENSIONS**

#### **POWERMITE**

CASE 457-04 ISSUE D

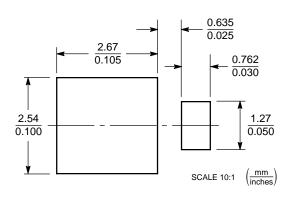


#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETER
- DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	1.75	2.05	0.069	0.081	
В	1.75	2.18	0.069	0.086	
С	0.85	1.15	0.033	0.045	
D	0.40	0.69	0.016	0.027	
F	0.70	1.00	0.028	0.039	
Н	-0.05	+0.10	-0.002	+0.004	
J	0.10	0.25	0.004	0.010	
K	3.60	3.90	0.142	0.154	
L	0.50	0.80	0.020	0.031	
R	1.20	1.50	0.047	0.059	
S	0.50	REF	0.019 REF		

## **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

POWERMITE is a registered trademark of and used under a license from Microsemi Corporation.

ON Semiconductor and un are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082-1312 USA Phone: 480-829-7710 or 800-344-3860 Toll Free USA/Canada Fax: 480-829-7709 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Japan: ON Semiconductor, Japan Customer Focus Center 2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051 Phone: 81-3-5773-3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative